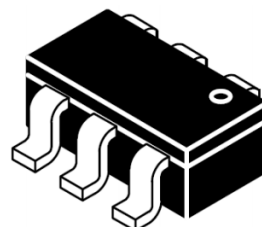


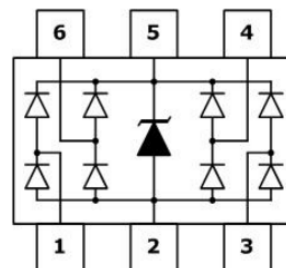
Features

- Ultra low leakage: nA level
- Operating voltage: 5V
- Low clamping voltage
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test
 - Air discharge: $\pm 30\text{kV}$
 - Contact discharge: $\pm 30\text{kV}$
 - IEC61000-4-4 (EFT) 40A (5/50ns)
 - IEC61000-4-5 (Lightning) 25A (8/20 μs)
- RoHS Compliant
- AEC-Q101 qualified.

Dimensions SOT-26



Pin Configuration



Applications

- USB 2.0 power and data line
- Set-top box and digital TV
- Digital video interface (DVI)
- Notebook Computers
- SIM Ports
- 10/100/1000 Ethernet

Mechanical Characteristics

- Package: SOT-26
- Lead Finish: Lead Free
- UL Flammability Classification Rating 94V-0
- Quantity Per Reel: 3,000 pcs
- Reel Size: 7 inch
- Device Marking: SRV05

Absolute Maximum Ratings (T_{amb}=25°C unless otherwise specified)

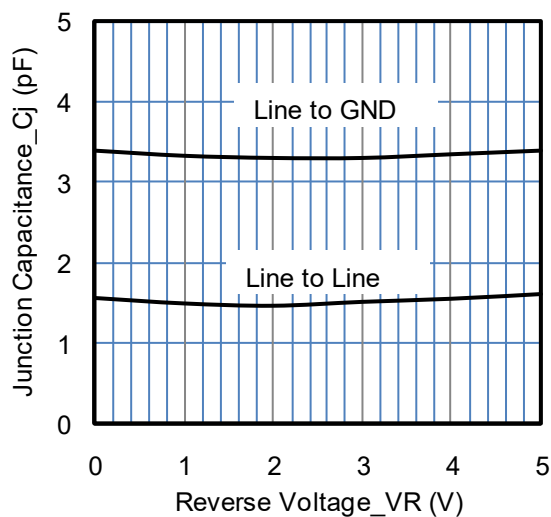
Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 μs)	P _{pp}	500	W
ESD per IEC 61000-4-2 (Air)	V _{ESD}	± 30	Kv
ESD per IEC 61000-4-2 (Contact)		± 30	
Operating Temperature Range	T _J	-55 to +125	°C
Storage Temperature Range	T _{STJ}	-55 to +150	°C

Electrical Characteristics (TA=25°C unless otherwise specified)

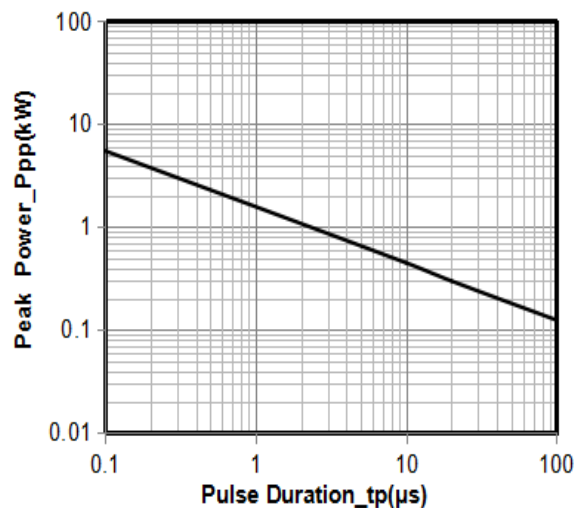
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			5	V	
Breakdown Voltage	VBR	6			V	IT = 1mA, Pin 5 to Pin 2
Reverse Leakage Current	IR			1	μA	VRWM = 5V, Pin 5 to Pin 2
Forward Voltage	VF			1.2	V	IF = 15mA
Clamping Voltage	VC			12	V	I _{PP} = 1A (8 x 20μs pulse), any I/O pin to ground
Clamping Voltage	VC			20	V	I _{PP} = 25A (8 x 20μs pulse), any I/O pin to ground
Junction Capacitance	CJ		1.5		pF	VR = 0V, f = 1MHz, between I/O pins
Junction Capacitance	CJ		3.0	5.0	pF	VR = 0V, f = 1MHz, any I/O pin to ground

Note 1: I/O pins are Pin 1, 3, 4 and 6

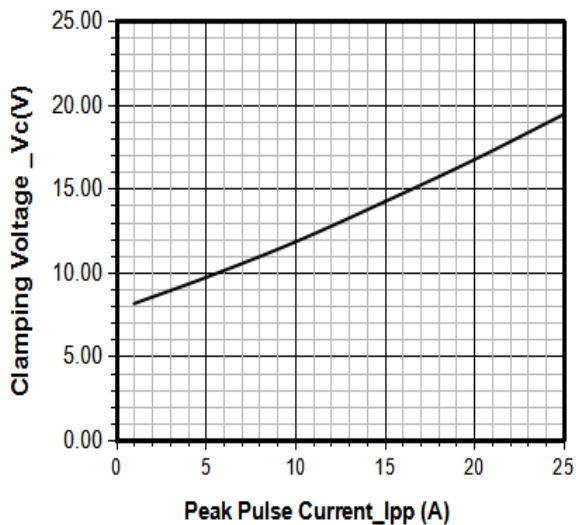
Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise Specified)



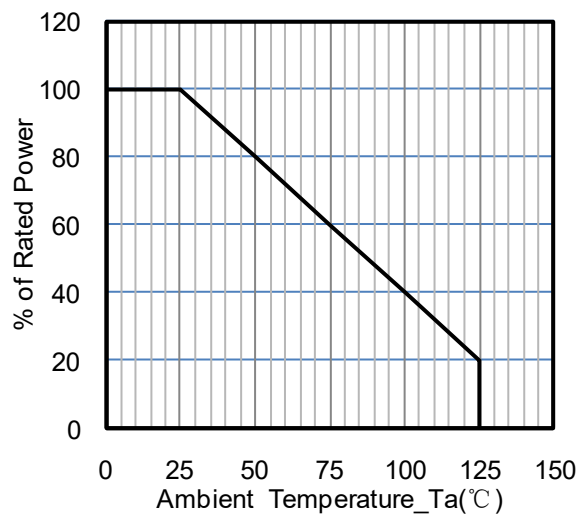
Junction Capacitance vs. Reverse Voltage



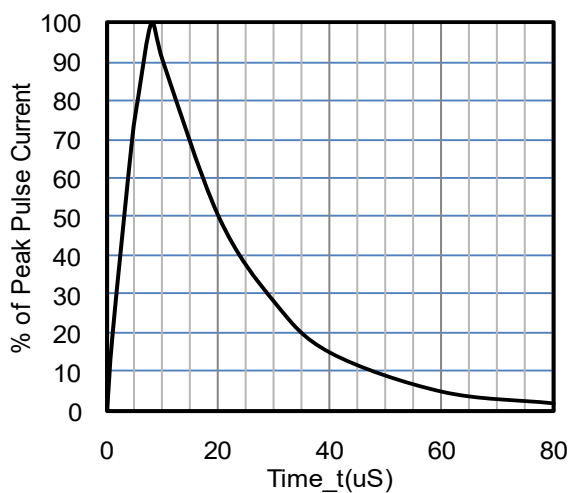
Peak Pulse Power vs. Pulse Time



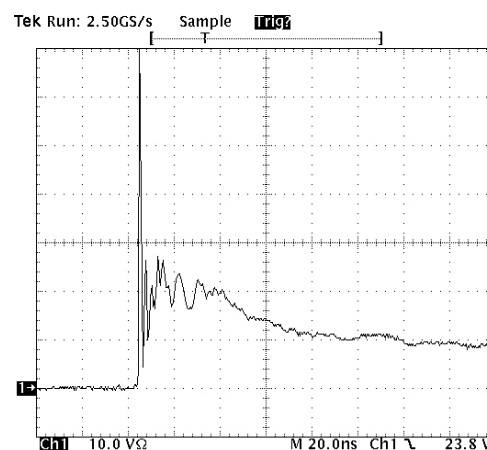
Clamping Voltage vs. Peak Pulse Current



Power Derating Curve



8 X 20 μs Pulse Waveform



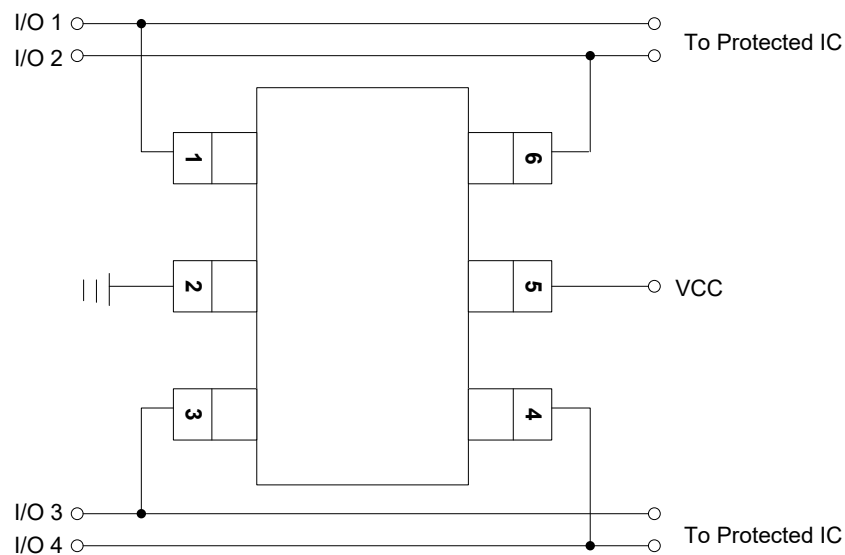
Note: Data is taken with a 10x attenuator

ESD Clamping Voltage

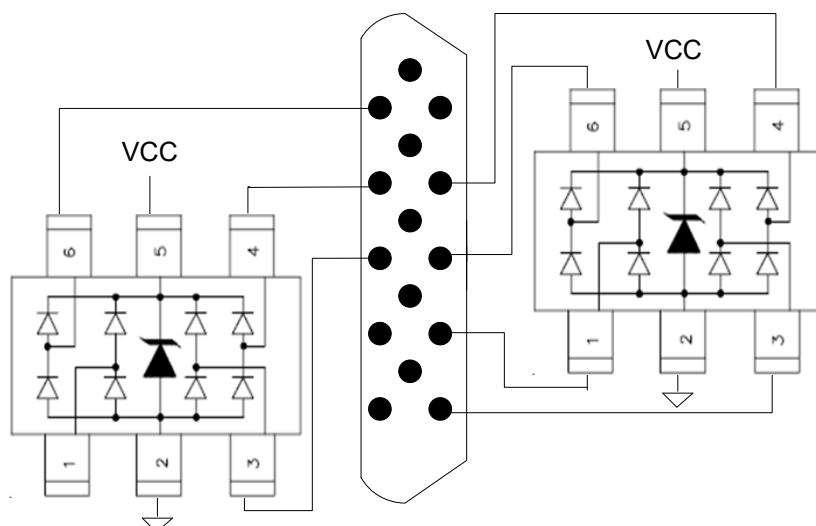
8 kV Contact per IEC61000-4-2

Typical Application

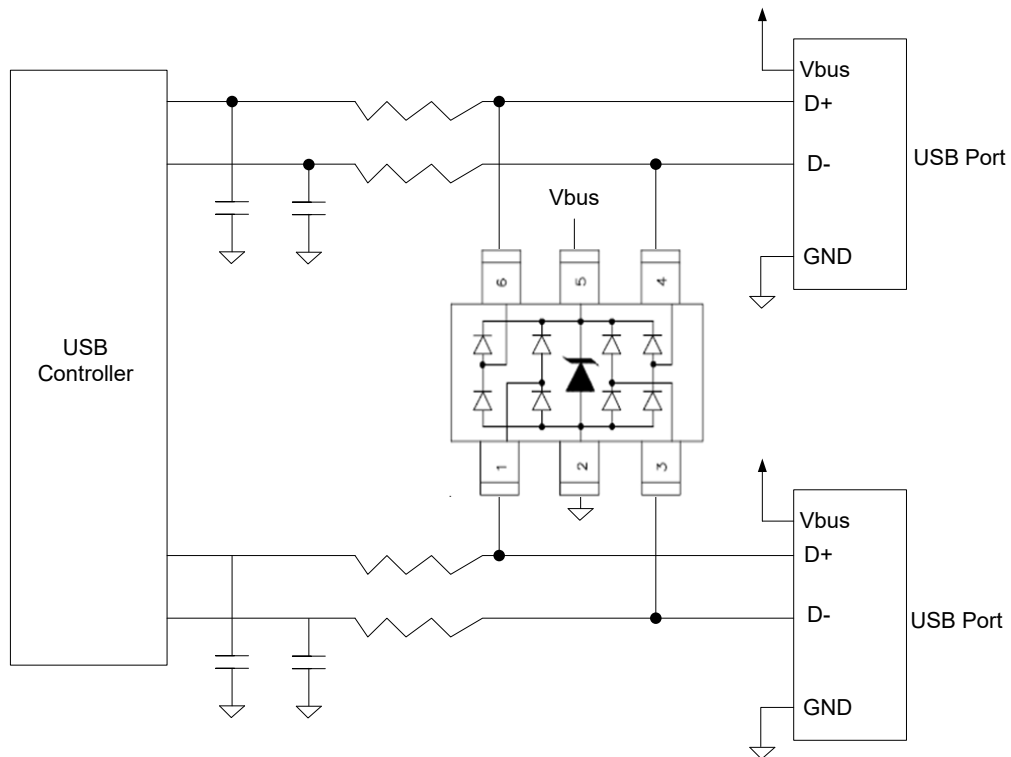
The UET26A05L05-IP38 is designed to protect four data lines from transient overvoltages by clamping them to fixed reference. When the voltage on the protected line exceeds the reference voltage (plus diode V_F) the steering diodes are forward biased, conducting the transient current away from the sensitive circuitry. Data lines are connected at pins 1, 3, 4 and 6. The negative reference (REF1) is connected at pin 2. This pin should be connected directly to a ground plane on the board for best results. The path length is kept as short as possible to minimize parasitic inductance. The positive reference (REF2) is connected at pin 5.



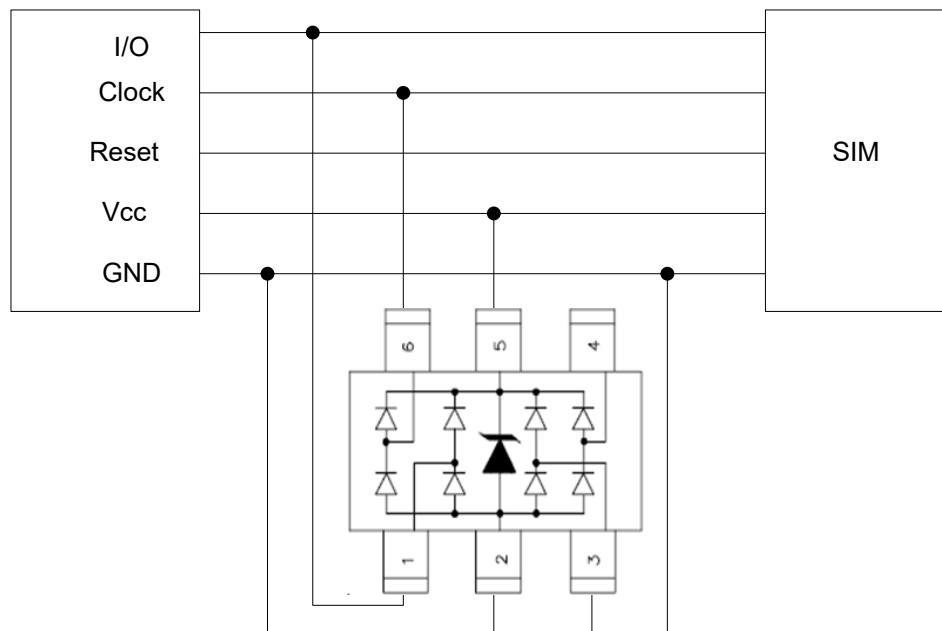
UET26A05L05-IP38 on Video Interface Application



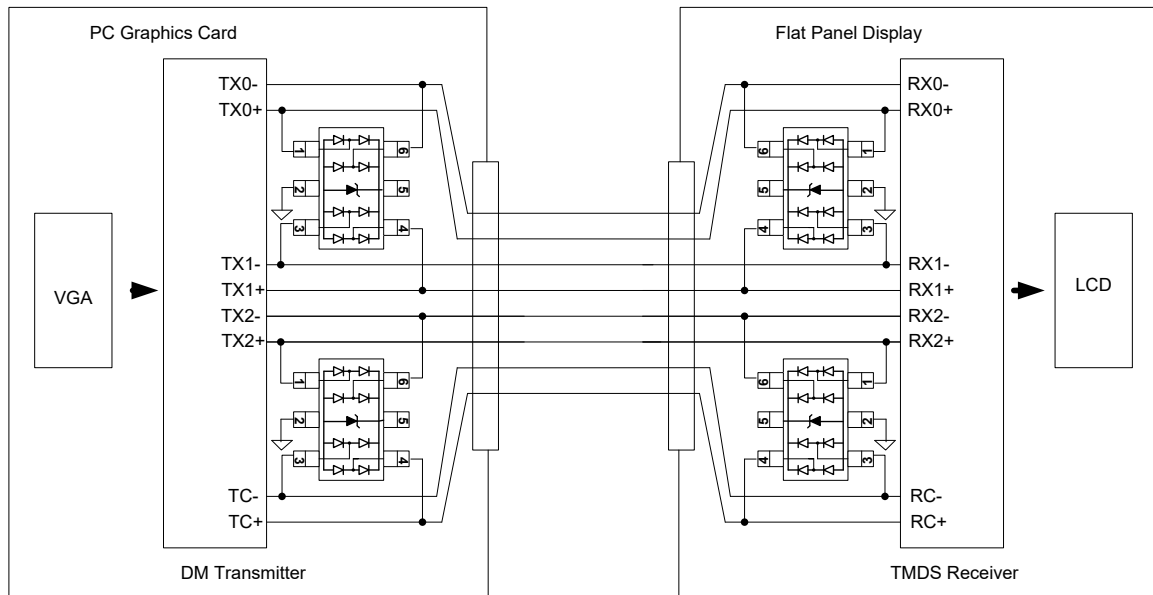
UET26A05L05-IP38 on USB Port Application



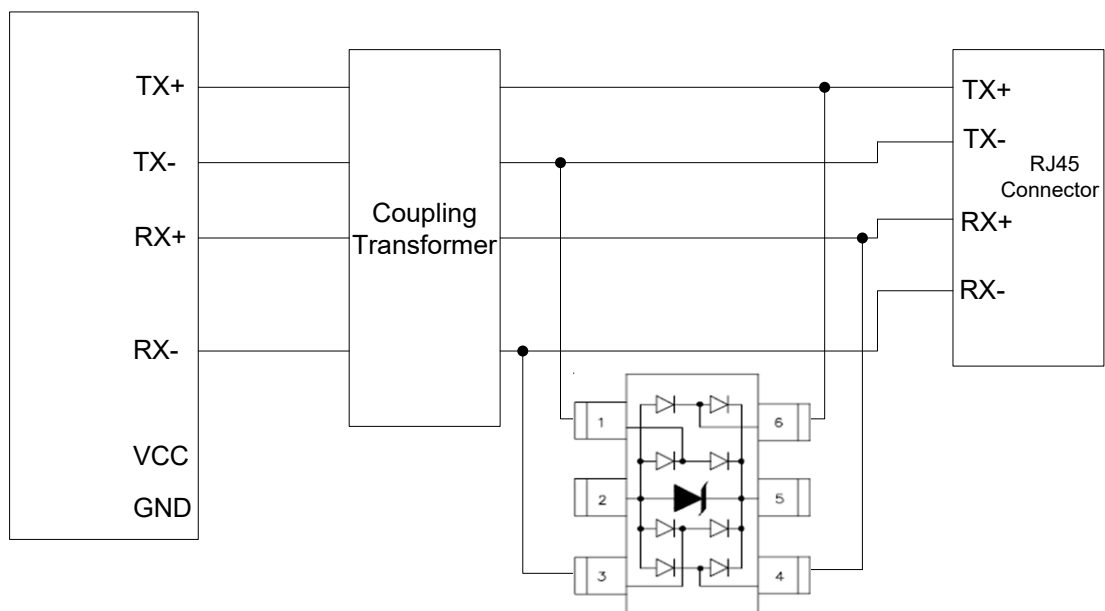
UET26A05L05-IP38 on SIM Port Application



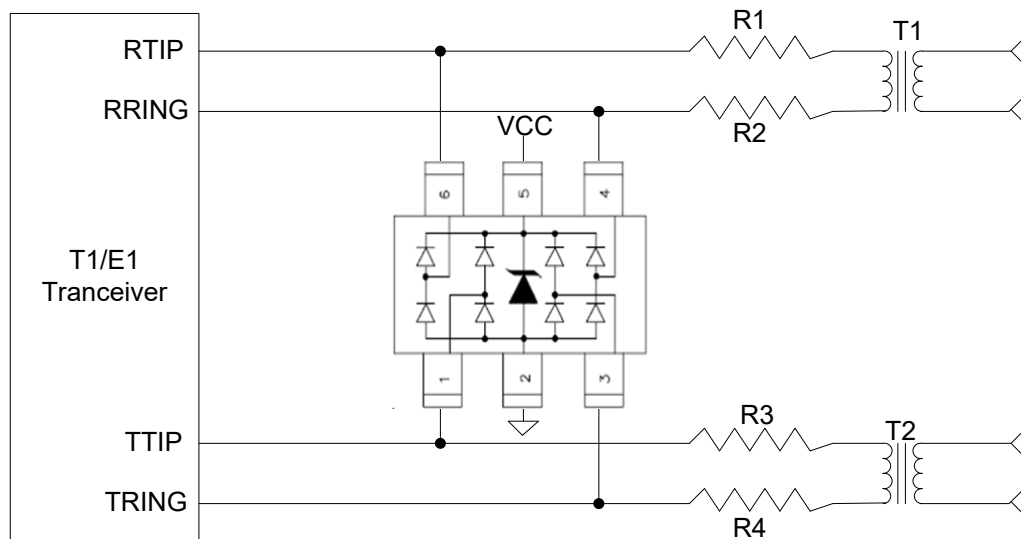
UET26A05L05-IP38 on Digital Visual Interface (DVI) Application



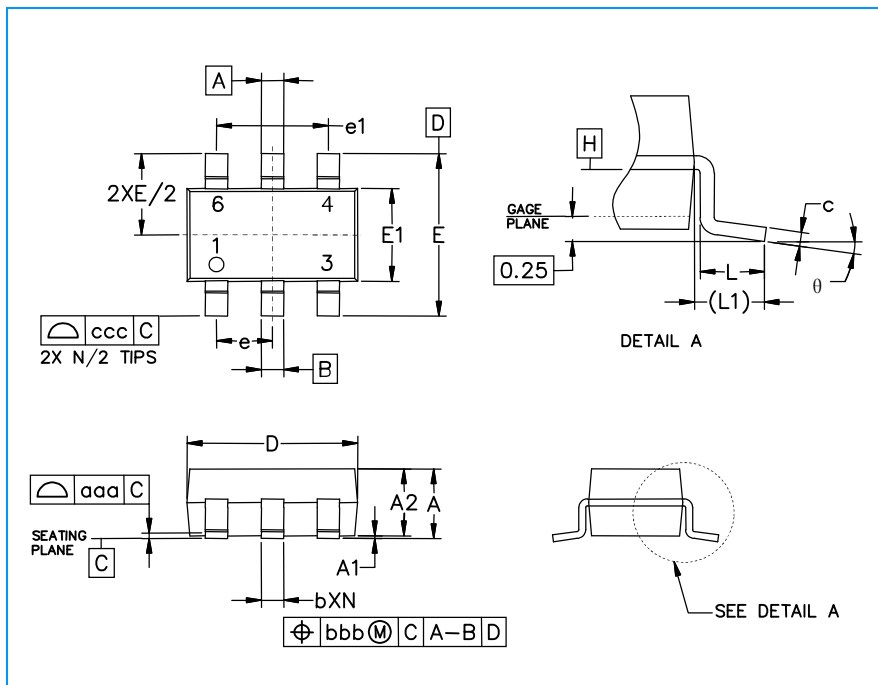
UET26A05L05-IP38 on Ethernet 10/100 (Differential mode) Application



UET26A05L05-IP38 on T1/E1 Interface Application

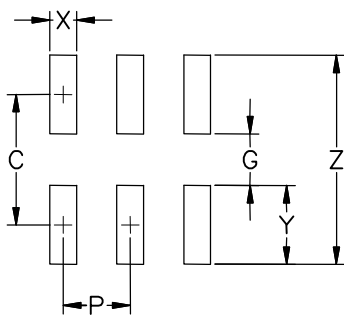


SOT-26 Package Outline & Dimensions



Symbol	Inches			Millimeters		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	0.035	-	0.057	0.90	-	1.45
A1	0.000	-	0.006	0.00	-	0.15
A2	0.035	0.045	0.051	0.90	1.15	1.30
b	0.010	-	0.020	0.25	-	0.50
c	0.003	-	0.009	0.08	-	0.22
D	0.110	0.114	0.122	2.80	2.90	3.10
E1	0.060	0.063	0.069	1.50	1.60	1.75
E	0.110 BSC			2.80 BSC		
e	0.037 BSC			0.95 BSC		
e1	0.075 BSC			1.90 BSC		
L	0.012	0.018	0.024	0.30	0.45	0.60
L1	(0.024)			(0.60)		
θ	0°	-	10°	0°	-	10°
aaa	0.004			0.10		
bbb	0.008			0.20		
ccc	0.008			0.20		

Soldering Footprint



Symbol	Inches	Millimeters
C	(0.098)	(2.50)
G	0.055	1.40
P	0.037	0.95
X	0.024	0.60
Y	0.043	1.10
Z	0.141	3.60